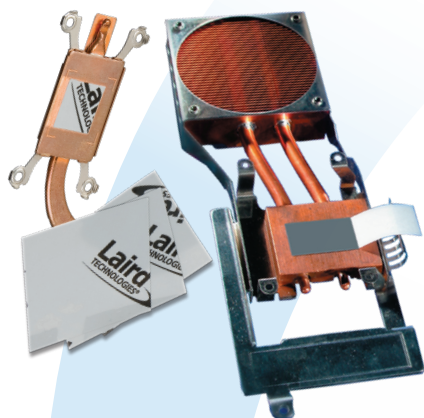




Tpcm™ 670 is a high performance, inherently tacky, easy to rework phase change thermal interface material. Developed specifically to meet the high thermal conductivity and low thermal resistance requirements of Intel® mobile processors. Tpcm 670 is optimized for multi-core and general CPU and GPU processors including Intel's Penryn Quad-Core mobile processor.

FEATURES AND BENEFITS

- Minimizes contact thermal resistance by filling the microscopic irregularities of the components it contacts. Begins to soften and flow at approximately 48°C.
- Designed to minimize migration (pump out) at CPU operating temperatures using a unique material formulation that softens, but does not fully change phase.
- Naturally tacky at room temperature, requiring no adhesive.
- Heat sink preheating not required.
- Supplied on tabbed liners for easy manual or automatic application.
- Exceptionally high reliability.
- Available with Laird Technologies easy release DF (patent pending) layer. DF (patent pending) minimizes the force required to disassemble after burn-in while still maintaining the highest possible thermal performance and exceptional reliability.

PROPERTIES	Tpcm™ 670	*Tpcm™ 670DF	TEST METHOD
Color	Grey		Visual
Thickness, inches (mm)	0.008" (0.20) 0.010 (.25)	0.005 (0.125) 0.008" (0.20) 0.010 (.25)	
Thickness Tolerance, inches (mm)	+/-0.001" (0.025)		
Construction & Composition	Non-reinforced Film		
Specific Gravity, g/cc	2.50		Helium Pycnometer
Shelf Life	1 year		
Operating Temperature Range, °C	-40 to 125°C		
Phase Change Softening Range, °C	45 to 70°C		
Thermal Conductivity, W/mK	4.3		Hot Disk Thermal Constants Analyzer
Thermal Resistance			
Outer core, 25 micron die height offset, °C-cm²/W, (°C-mm²/W)	0.117 (11.7)		Intel Mobile TIM Tester
50 psi °C-in²/ W	0.010	0.025	ASTM D5470 (modified)
345 Kpa, °C-cm²/W	0.065	0.161	ASTM D5470 (modified)

* patent pending

global solutions: local support™

Americas: +1.800.843.4556

Europe: +49.8031.2460.0

Asia: +86.755.2714.1166

CLV-customerservice@lairdtech.com

www.lairdtech.com/thermal

THR-DS-Tpcm-670-670DF 0910

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В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9